

# PCIe® Gen 3 NVMe M.2 2280 / 2242 / 2230 SSD

The Global Leader in Specialized Storage and Memory Solutions





### **Key Features**

- MCU-based Power Loss Protection Design with Level 4 (data-in-flight) protection\*
- Self-Encrypting Drive (SED) with AES 256-bit encryption, TCG Opal 2.0\*
- Thermal Heatsink Solutions\*\*

End-to-End Data Path ProtectionTRIM function support

\* May vary by product and project support \*\* Customization available on a project basis

ATP's M.2 2280 NVMe solid state modules based on the NVMe<sup>™</sup> protocol and leveraging the PCI Express<sup>®</sup> (PCIe<sup>®</sup>) Gen3 x4 interface deliver speedy, reliable, and enduring performance to fulfill the increasing data storage demands of today's embedded and industrial applications.

Constructed with 3D triple level cell (TLC) NAND flash, these modules are available in different capacities, ranging from 40 GB to 3.84 TB, to meet diverse data storage needs.

ATP NVMe SSDs with industrial operating temperature rating deliver stable performance even in extreme temperatures ranging from -40°C to 85°C.

Select ATP M.2 2280 NVMe modules adopt a Customizable Thermal Management Solution. This includes firmware and hardware options, such as copper foil and fin-type heatsink, to effectively dissipate heat and ensure optimal levels of sustained performance.

**PRODUCT FLYER** | PCIe<sup>®</sup> Gen 3 NVMe M.2 2280 / 2242 / 2230 SSD

### Specifications

		PCIe <sup>®</sup> Gen 3 N	VMe M.2 2280	/ 2242 / 223	30 SSD				
Product Line									
Interface	N750Pi	N700Pi	N700Pi	N700Pc	N650Si	N650Sc	N600Si	N600Sc	
Interface Flash Type	3D TLC (n	SI ( mode)				3D.	TLC		
Form Factor	3D TLC (pSLC mode) M.2 2280-D2-M		3D TLC (pSLC mode) M.2 2230-S4-M		M.2 2280-D2-M				
	-40°C to 85°C		-40°C to 85°C 0°C to 70°C		-/\0°C to 85°C	-40°C to 85°C 0°C to 70°C -40°C to 85°C 0°C to 70°C			
Operating Temperature (Tcase) <sup>1</sup> Power Loss Protection Options	Hardware + Firmware Based		Firmwar		Hardware + Firmware Based or Firmware Based				
Optional SED Features	Haluwale + F		AES 256-bit Encry			+ FIIIIWale Dase	ed of Firmware bas	eu	
Capacity	40 GB to 320 GB	40 GB to 640 GB	40 GB to			to 960 GB	120 GB to	2 0/. TD	
capacity	40 00 10 520 00	40 00 10 040 00	Perfor		120 00	10 900 GB	120 GB to	5.64 10	
Sequential Read (MB/s) up to	3.	150	2,0			3	420		
Sequential Write (MB/s) up to	2,670	2,820					050		
Random Reads IOPS up to		7,789		1,600 135,600		2,700	225,200		
Random Writes IOPS up to		,705	133,			5,600	179,200		
··		,,	Endurance ar						
Endurance (TBW) <sup>2</sup> up to	16,000 TB	21,300 TB	4,28	,	4.6	40 TB	10,600	TB	
Endurance (TBW) <sup>2</sup> up to Reliability MTBF @ 25°C	10,000 10	21,50010	>2,000,0		4,0		10,000		
Reliability WIDP (@ 25 C			>2,000,0 Oth						
	800x220x25/M22	280 Bare DCBA	001	0.5	80.0 × 2	20x35/M2220	BO Bare DCBAL		
Dimensions (mm)	80.0 x 22.0 x 3.5 (M.2 2280 Bare PCBA) 80.0 x 24.4 x 12.5 (M.2 2280 with 8 mm heatsink)		30.0 x 22.0 x 2.5		80.0 x 22.0 x 3.5 (M.2 2280 Bare PCBA) 80.0 x 24.4 x 12.5 (M.2 2280 with 8 mm heatsink)				
Certifications		CE, FCC, BSMI, UKC	A, RoHS, REACH		CE, FCC, BSMI, UKCA, F	RoHS, and REACH are	available for SSD models E/FCC are available for t	s with capacities	
Warranty	5.	rears				ears	L/ FCC are available for b	ne 3.64 TB 33D Model.	
					- 1	cars			
PCIe	Gen 3 NVMe M.2 2	2280 / 2242 / 2230	SSD						
Product Line									
	N600Vc	N600Vc	N600Vi	N600V	<sup>c</sup>				
Interface		PCIe G3 x							
Flash Type		3D TLC							
Form Factor	M.2 2280 52-M	M.2 2242 D5-M		30-54-M					
Operating Temperature (Tcase) <sup>1</sup>	0°C to		-40°C to 85°C	0°C to 70	J°C				
Power Loss Protection Options		Firmware E	ased						
Optional SED Features	120 CD to (		12000	ta ( 00CD					
Capacity	120 GB to 9	Performar		to 480GB					
Sequential Dead (MB/c) up to	2,60			50					
Sequential Read (MB/s) up to Sequential Write (MB/s) up to	1,87								
Random Reads IOPS up to	1,87		1,550						
Random Reads IOPS up to Random Writes IOPS up to	145,9		138,						
nanashi wincə iərə up to	143,5	Endurance and							
Endurance (TBW) <sup>2</sup> up to	1,390		768	TB					
Reliability MTBF @ 25°C	1,390	>2,000,000							
Reliability WIBP (@ 25 C		>2,000,000 Others							
Dimensions (mm)	80.0 x 22.0 x 2.2	42.0 x 22.0 x 3.6		2.0 x 2.5					
Certifications		CE, FCC, BSMI, UKCA	, RoHS, REACH						
Warranty		2 year	S						
							1	And	
Technologies &				)     -   -   -   -   -   -   -   -   -					
Add-On Services	S.M.A.R.T. Firmware-based Hardw Power Loss Pow Protection Pri	vare-based ver Loss ver Loss	ar Dynamic Data End-to- Refresh Data Pata Pata Pata Pata Pata Pata Pata			namic Thermal Industrial Throttling Temperature	Anti-Sulfur Conforma Resistors Coating	al Joint Validation	
Premium	O O	O O O	O O	O		- 0		_	
PCle <sup>®</sup> Gen3 NVMe M.2 2280 / 2242 / 2230	0 0	▲ 0 0	0 0	0					
Wi.2 22807 22427 2230 Value	0 0	- 0 0	0 0	0				_	
Value	, ,								

1 Case Temperature, the composite temperature as indicated by SMART temperature attributes.

2 Under highest Sequential write value. May vary by density, configuration and applications.
A: Customization option available on a project basis.

Hot Items Ordering Information									
Product Line	Capacity <sub>1</sub>	Operating Temperature <sub>2</sub>	Power Loss Protection <sub>3</sub>	SED <sub>4</sub>	P/N				
N650Si	120GB	-40°C to 85°C	Hardware + Firmware Based	-	AF120GSTJA-8BCIP				
N650Si	240GB	-40°C to 85°C	Hardware + Firmware Based	-	AF240GSTJA-8BCIP				
N650Si	480GB	-40°C to 85°C	Hardware + Firmware Based	-	AF480GSTJA-8BCIP				
N650Si	960GB	-40°C to 85°C	Hardware + Firmware Based	-	AF960GSTJA-8BCIP				
N650Sc	120GB	0°C to 70°C	Hardware + Firmware Based	-	AF120GSTJA-8BCXP				
N650Sc	240GB	0°C to 70°C	Hardware + Firmware Based	-	AF240GSTJA-8BCXP				
N650Sc	480GB	0°C to 70°C	Hardware + Firmware Based	-	AF480GSTJA-8BCXP				
N650Sc	960GB	0°C to 70°C	Hardware + Firmware Based	-	AF960GSTJA-8BCXP				
N6005c	120GB	0°C to 70°C	Hardware + Firmware Based	-	AF120GSTJA-8BAXP				
N600Sc	240GB	0°C to 70°C	Hardware + Firmware Based	-	AF240GSTJA-8BAXP				
N600Sc	480GB	0°C to 70°C	Hardware + Firmware Based	-	AF480GSTJA-8BAXP				
N6005c	960GB	0°C to 70°C	Hardware + Firmware Based	-	AF960GSTJA-8BAXP				
N600Sc	1920GB	0°C to 70°C	Hardware + Firmware Based	-	AF1T92STJA-8BAXP				
N6005c	120GB	0°C to 70°C	Firmware Based	-	AF120GSTJA-8BAXX				
N600Sc	240GB	0°C to 70°C	Firmware Based	-	AF240GSTJA-8BAXX				
N6005c	480GB	0°C to 70°C	Firmware Based	-	AF480GSTJA-8BAXX				
N600Sc	960GB	0°C to 70°C	Firmware Based	-	AF960GSTJA-8BAXX				
N600Sc	1920GB	0°C to 70°C	Firmware Based	-	AF1T92STJA-8BAXX				
N600Vc (M.2 NVMe 2280)	120GB	0°C to 70°C	Firmware Based	-	AF120GSTJA-DBCXX				
N600Vc (M.2 NVMe 2280)	240GB	0°C to 70°C	Firmware Based	-	AF240GSTJA-DBCXX				
N600Vc (M.2 NVMe 2280)	480GB	0°C to 70°C	Firmware Based	5 -	AF480GSTJA-DBCXX				
N600Vc (M.2 NVMe 2242)	120GB	0°C to 70°C	Firmware Based	-	AF120GSTJC-DBBXX				
N600Vc (M.2 NVMe 2242)	240GB	0°C to 70°C	Firmware Based	-	AF240GSTJC-DBBXX				
N600Vc (M.2 NVMe 2242)	480GB	0°C to 70°C	Firmware Based	-	AF480GSTJC-DBBXX				
N600Vc (M.2 NVMe 2242)	960GB	0°C to 70°C	Firmware Based	-	AF960GSTJC-DBBXX				

1 Amount of actual usable storage that can be utilized.

2 Refers to Case Temperature range during device operation, as indicated by SMART temperature attributes.

3 Hardware + Firmware-based power loss protection design with Level 4 (data-in-flight) protection; Firmware-based power loss protection design with Level 1 (data-at-rest) protection.

4 Allows data written to and read from the SSD to be constantly and automatically encrypted and decrypted. Conforms to TCG Opal 2.0 and uses AES 256-bit HW encryption.

Product spec and its related information are subject to change without advance notice. Please refer to <u>www.atpinc.com</u> for latest information

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